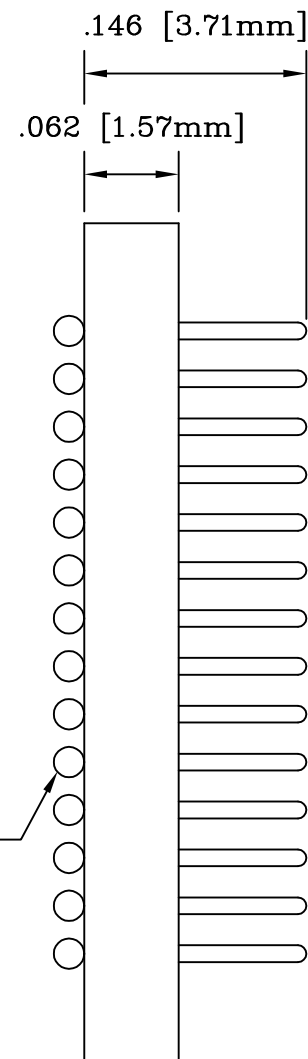
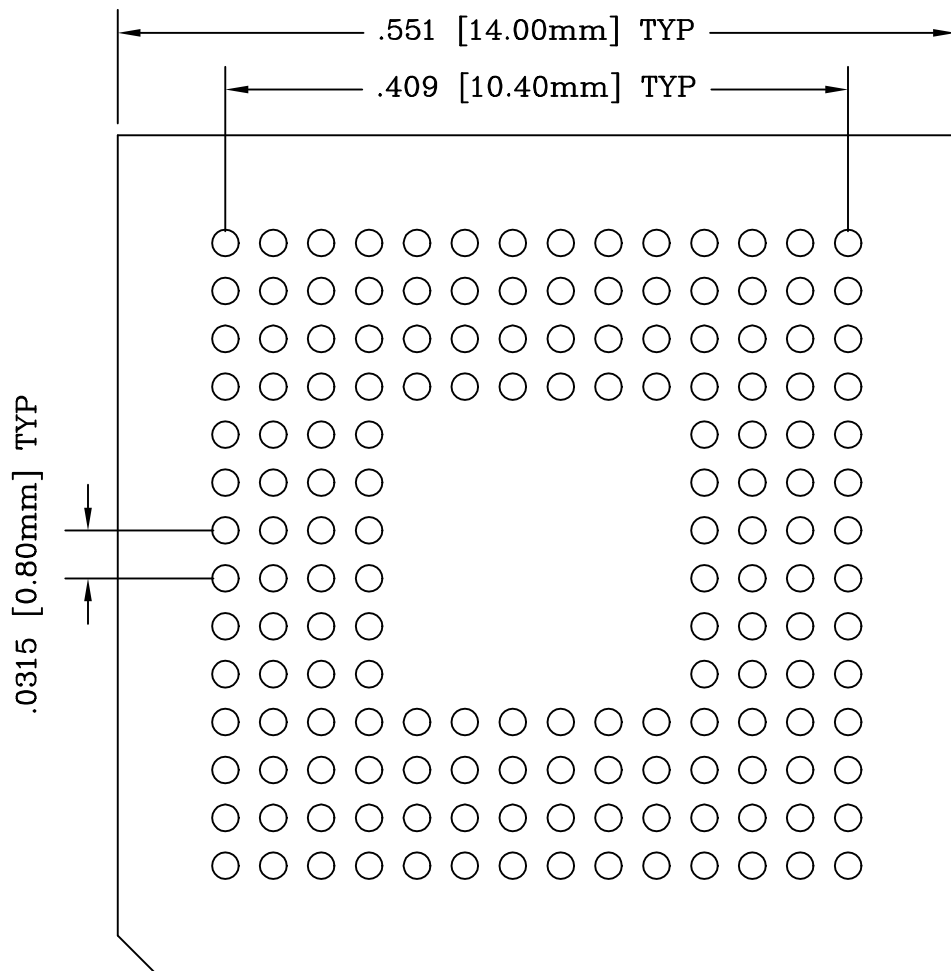


REV	DESCRIPTION	DATE	BY
A	NEW DRAWING	06/19/03	H.N.

F6972
DOD 36972



SOLDER SPHERE
63% Sn - 37% Pb
ø.020 [ø0.51mm]

PACKAGE SPECIFICATIONS	
PIN COUNT	= 160
LEAD PITCH	= 0.80mm
GRID SIZE	= 14x14
PACKAGE SIZE	= 14.00mm SQ

NOTES:

- MATERIALS:**
INSULATOR: FR-4 GLASS EPOXY U.L.
RATED 94V-0, (UNCLAD) COLOR: BLACK.
TERMINAL: BRASS, C36000, ASTM-B-16
- PLATING:**
TERMINAL: .000010 [0.000254mm] MIN. GOLD OVER
.000050 [0.00127mm] MIN. NICKEL

ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE SPECIFIED



Emulation Technology, Inc.

— VLSI and SMT ADAPTERS and ACCESSORIES —

2344 Walsh Avenue, Bldg.F Santa Clara, Ca 95051
TEL:(408)982-0660 FAX:(408)982-0664

SHEET: 1 OF 1	DATE: 06/19/03	REVISION: A	ASSEMBLY DRAWING
CHECKED: Perry Munroe	DRAWN: Huy Nguyen	ITEM: FPA-160-6-014-B	DESCRIPTION: FPA-160-6BG014-BL
Scale 8:1	DO NOT SCALE DRAWING		